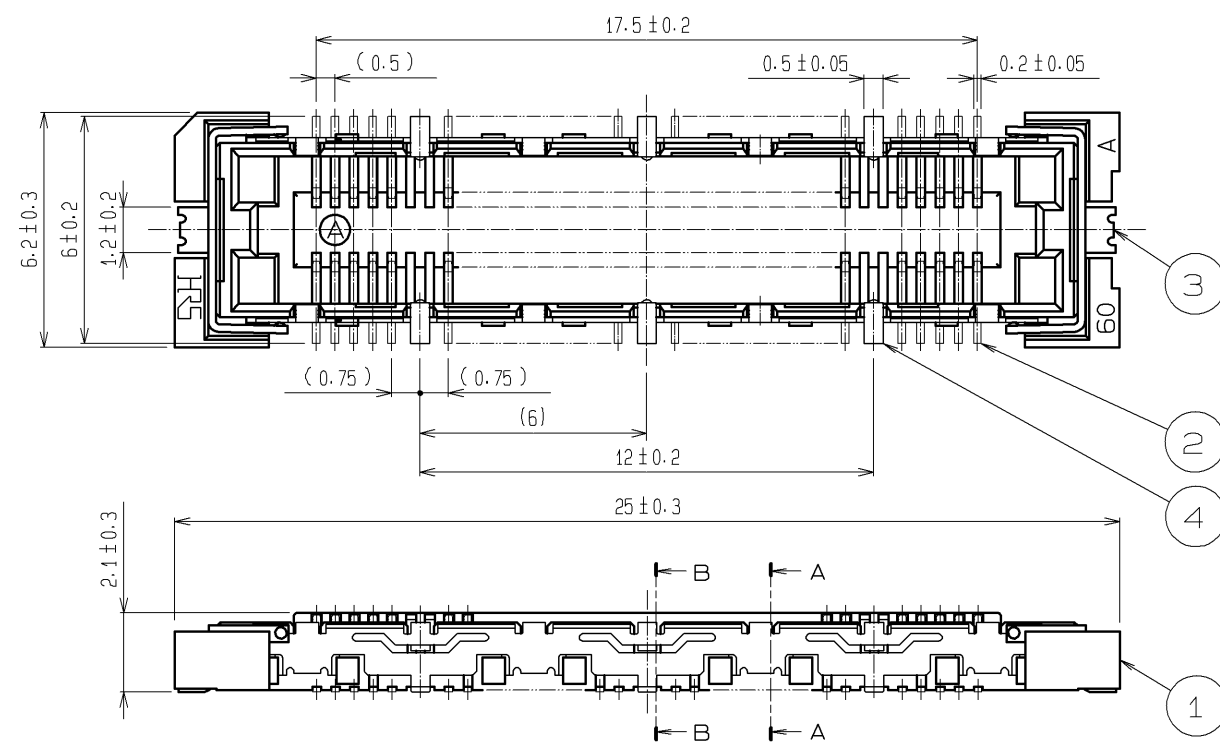
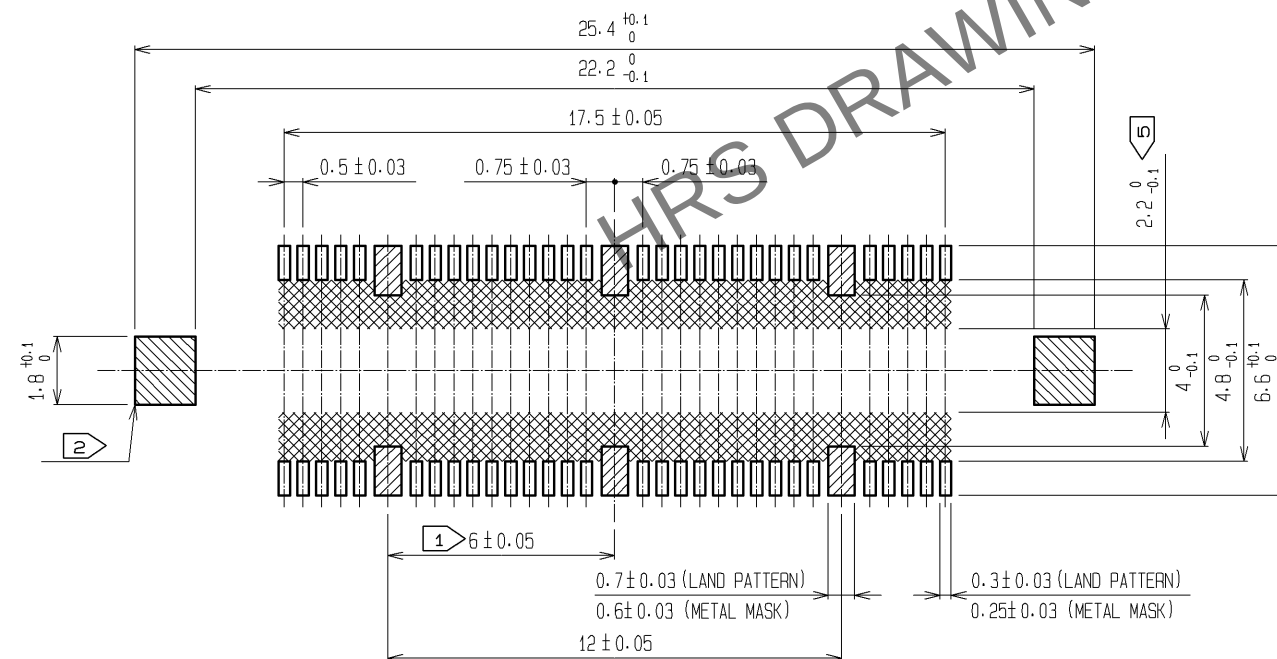


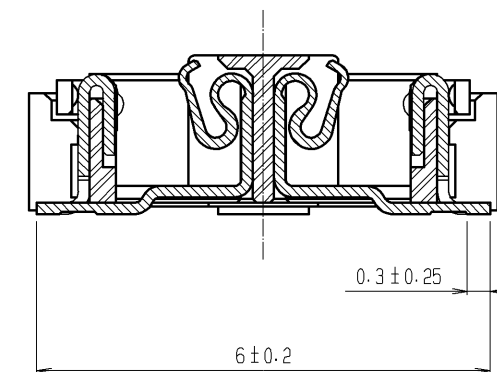


RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)

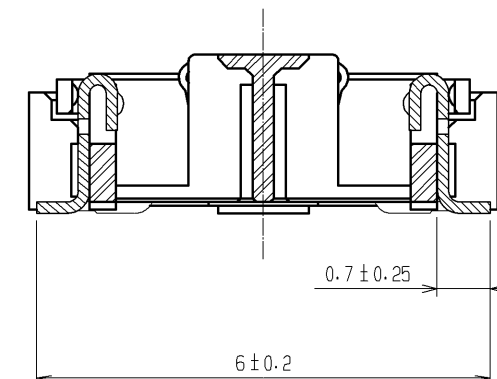


- NOTES
- ① 6 HATCHED PARTS: GROUND CIRCUIT.
 - ② 2 HATCHED PARTS: GROUND CIRCUIT.
 - ③ SMT LEAD-COPLANARITY: 0.1 MAX.
 - ④ THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - ⑤ MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND .OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - ⑥ THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

A-A (10 : 1)



B-B (10 : 1)



3, 4	PHOSPHOR BRONZE	TIN PLATING	2	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.
1	LCP	BEIGE UL94V-0			LEAD AREA : GOLD 0.05μm min.
					UNDER PLATING : NICKEL 1μm min.
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS
UNITS mm		SCALE 5 : 1	COUNT 	DESCRIPTION OF REVISIONS	DESIGNED
					CHECKED
					DATE
HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA	12.03.08	DRAWING NO.	EDC3-152636-25
		CHECKED : HT. YAMAGUCHI	12.03.08	PART NO.	FX11B-60S/6-SV(71)
		DESIGNED : TS. MIYAKI	12.03.08	CODE NO.	CL573-0712-2-71
		DRAWN : TS. MIYAKI	12.03.08		